

FSA2257

Low R_{ON} Low Voltage Dual SPDT Bi-Directional Analog Switch

General Description

The FSA2257 is a high performance bi-directional dual Single Pole Double Throw (SPDT) analog switch. This switch can be configured as either a multiplexer or a demultiplexer by select pins. The device features ultra low R_{ON} of 1.3Ω maximum at $4.5V V_{CC}$ and will operate over the wide V_{CC} range of $1.65V$ to $5.5V$. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation. The select input is TTL level compatible.

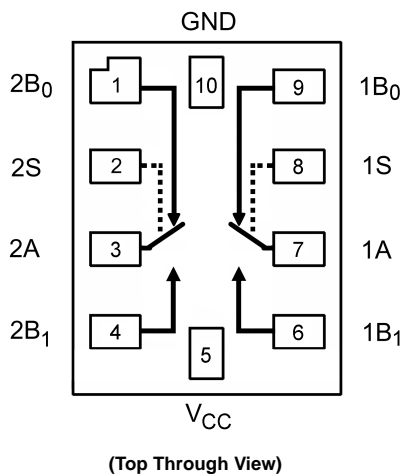
Features

- Maximum 1.15Ω ON Resistance (R_{ON}) for $4.5V$ supply
- 0.3Ω max R_{ON} flatness for $+5V$ supply
- Space saving MicroPak™ packaging
- Broad V_{CC} operating range: $1.65V$ to $5.5V$
- Fast turn-on and turn-off time
- Break-before-make enable circuitry
- Over-voltage tolerant TTL compatible control input

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
FSA2257L10X	MAC010A	EP	10-Lead MicroPak, 1.6 mm x 2.1mm	5K Units on Tape and Reel

Analog Symbols



Truth Table

Control Input(s)	Function
L	B_0 Connected to A
H	B_1 Connected to A

H = HIGH Logic Level
L = LOW Logic Level

Pin Descriptions

Pin Names	Function
A, B_0 , B_1	Data Ports
S	Control Input

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Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	-0.5V to +6.0V
Switch Voltage (V_S) (Note 2)	-0.5V to $V_{CC} + 0.5V$
Input Voltage (V_{IN}) (Note 2)	-0.5V to +6.0V
Input Diode Current	-50 mA
Switch Current	200 mA
Peak Switch Current (Pulsed at 1 ms duration, <10% Duty Cycle)	400 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
Maximum Junction Temperature (T_J)	+150°C
Lead Temperature (T_L)	
Soldering, 10 seconds	+260°C
ESD	
Human Body Model	8000V

Recommended Operating Conditions

Supply Voltage (V_{CC})	1.65V to 5.5V
Control Input Voltage (V_{IN}) (Note 3)	0V to V_{CC}
Switch Input Voltage (V_{IN})	0V to V_{CC}
Operating Temperature (T_A)	-40°C to +85°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics (All typical values are @ 25°C unless otherwise specified)

Symbol	Parameter	V_{CC} (V)	$T_A = +25^\circ\text{C}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions
			Min	Typ	Max	Min	Max		
V_{IH}	Input Voltage High	2.7 to 3.6				2.0		V	
		4.5 to 5.5				2.4			
V_{IL}	Input Voltage Low	2.7 to 3.6					0.6	V	
		4.5 to 5.5					0.8		
I_{IN}	Control Input Leakage	2.7 to 3.6				-1.0	1.0	μA	$V_{IN} = 0V \text{ to } V_{CC}$
		4.5 to 5.5				-1.0	1.0		
$I_{NO(OFF)}$, $I_{NC(OFF)}$	OFF-Leakage Current of Port B_0 and B_1	5.5	-2.0		2.0	-20.0	20.0	nA	A = 1V, 4.5V B_0 or $B_1 = 1V, 4.5V$
$I_{A(ON)}$	ON Leakage Current of Port A	5.5	-4.0		4.0	-40.0	40.0	nA	A = 1V, 4.5V B_0 or $B_1 = 1V, 4.5V$ or Floating
R_{ON}	Switch ON Resistance (Note 4)	2.7		2.6	4.0		4.3	Ω	$I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 1.5V$ $I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 3.5V$
		4.5		0.95	1.15		1.3		
ΔR_{ON}	ON Resistance Matching Between Channels (Note 5)	2.7						Ω	$I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 1.5V$ $I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 3.5V$
		4.5		0.06	0.12		0.15		
$R_{FLAT(ON)}$	ON Resistance Flatness (Note 6)	2.7		1.4				Ω	$I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 0V, 0.75V, 1.5V$ $I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 0V, 1V, 2V$
		4.5		0.2	0.3		0.4		
I_{CC}	Quiescent Supply Current	3.6		0.1	0.5		1.0	μA	$V_{IN} = 0V \text{ or } V_{CC}, I_{OUT} = 0V$
		5.5		0.1	0.5		1.0		

Note 4: ON Resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.

Note 5: $\Delta R_{ON} = R_{ONmax} - R_{ONmin}$ measured at identical V_{CC} , temperature, and voltage.

Note 6: Flatness is defined as the difference between the maximum and minimum value of ON Resistance over the specified range of conditions.

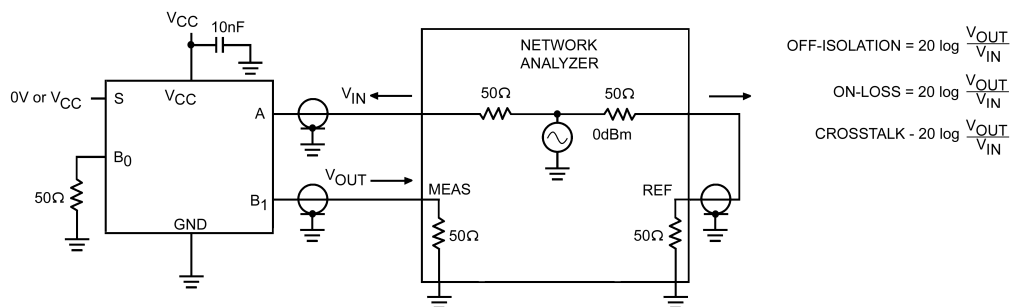
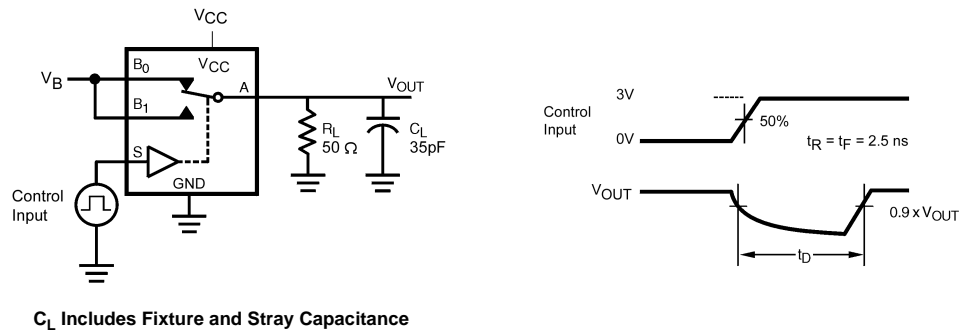
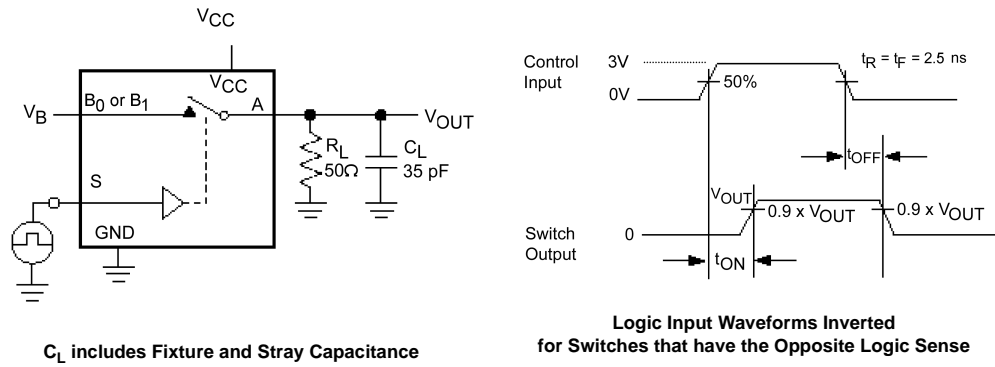
AC Electrical Characteristics (All typical value are @ 25°C unless otherwise specified)

Symbol	Parameter	V _{CC} (V)	T _A = +25°C			T _A = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t _{ON}	Turn ON Time	2.7 to 3.6			50.0		60.0	ns	B ₀ or B ₁ = 1.5V, R _L = 50Ω, C _L = 35 pF	Figure 1
		4.5 to 5.5			35.0		40.0		B ₀ or B ₁ = 3.0V, R _L = 50Ω, C _L = 35 pF	
t _{OFF}	Turn OFF Time	2.7 to 3.6			20.0		30.0	ns	B ₀ or B ₁ = 1.5V, R _L = 50Ω, C _L = 35 pF	Figure 1
		4.5 to 5.5			15.0		20.0		B ₀ or B ₁ = 3.0V, R _L = 50Ω, C _L = 35 pF	
t _{B-M}	Break-Before-Make Time	2.7 to 3.6				1.0		ns	B ₀ or B ₁ = 1.5V, R _L = 50Ω, C _L = 35 pF	Figure 2
		4.5 to 5.5		20.0		1.0			B ₀ or B ₁ = 3.0V, R _L = 50Ω, C _L = 35 pF	
Q	Charge Injection	2.7 to 3.6		20.0				pC	C _L = 1.0 nF, V _{GEN} = 0V, R _{GEN} = 0Ω	Figure 4
		4.5 to 5.5		10.0						
OIRR	OFF-Isolation	2.7 to 3.6		-70.0				dB	f = 1MHz, R _L = 50Ω	Figure 3
		4.5 to 5.5		-70.0						
Xtalk	Crosstalk	2.7 to 3.6		-75.0				dB	f = 1MHz, R _L = 50Ω	Figure 3
		4.5 to 5.5		-75.0						
BW	-3db Bandwidth	2.7 to 3.6		350				MHz	R _L = 50Ω	Figure 6
		4.5 to 5.5		350						
THD	Total Harmonic Distortion	2.7 to 3.6		0.002				%	R _L = 600Ω, V _{IN} = 0.5V P.P, f = 20Hz to 20kHz	Figure 7
		4.5 to 5.5		0.002						

Capacitance

Symbol	Parameter	V _{CC} (V)	T _A = +25°C			T _A = 40°C to +85°C		Units	Conditions
			Min	Typ	Max	Min	Max		
C _{IN}	Control Pin Input Capacitance	0.0		3.5				pF	f = 1MHz (see Figure 5)
C _{OFF}	B Port OFF Capacitance	4.5		12.0				pF	f = 1MHz (see Figure 5)
C _{ON}	A Port ON Capacitance	4.5		40.0				pF	f = 1MHz (see Figure 5)

AC Loading and Waveforms



AC Loading and Waveforms (Continued)

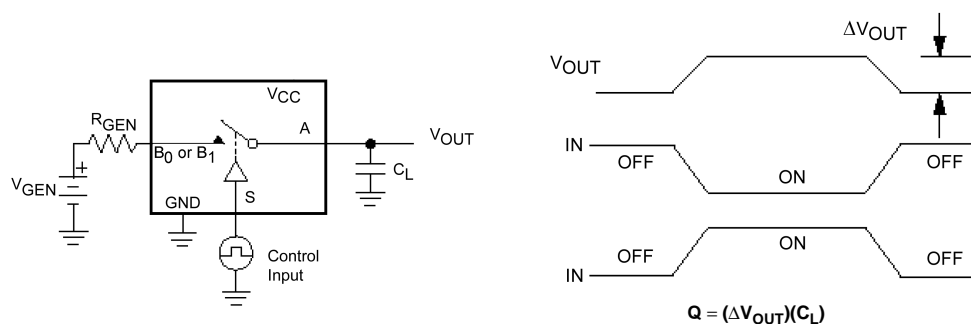


FIGURE 4. Charge Injection

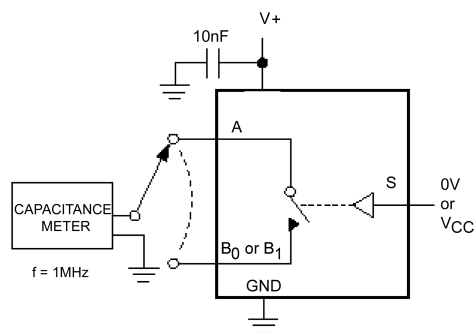


FIGURE 5. ON/OFF Capacitance Measurement Setup

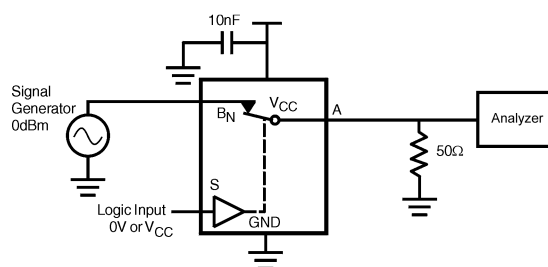


FIGURE 6. Bandwidth

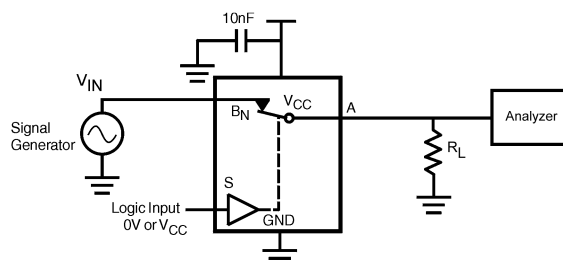
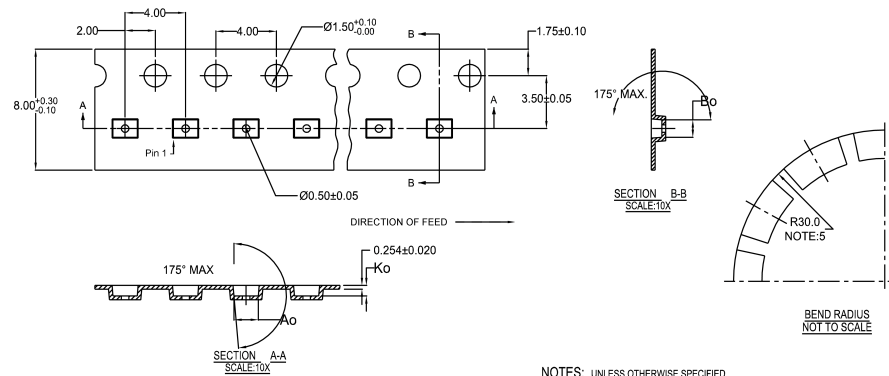


FIGURE 7. Harmonic Distortion

Tape and Reel Specification

Tape Format For Micropak 10

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L10X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed



10	300056	2.30 ± 0.05	1.78 ± 0.05	0.68 ± 0.05
8	300038	1.78 ± 0.05	1.78 ± 0.05	0.68 ± 0.05
6	300033	1.60 ± 0.05	1.15 ± 0.05	0.70 ± 0.05

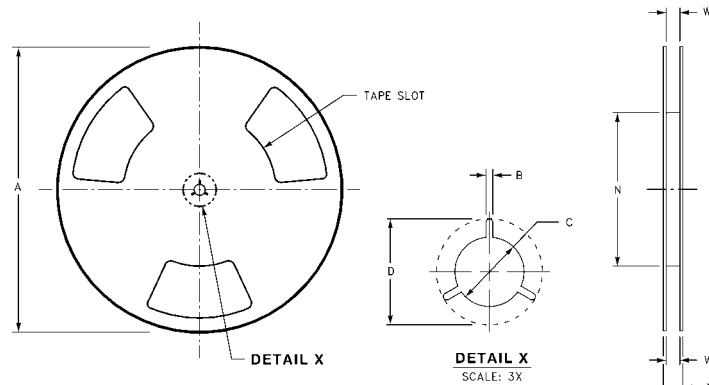


SCALE: 6X

NOTES: UNLESS OTHERWISE SPECIFIED

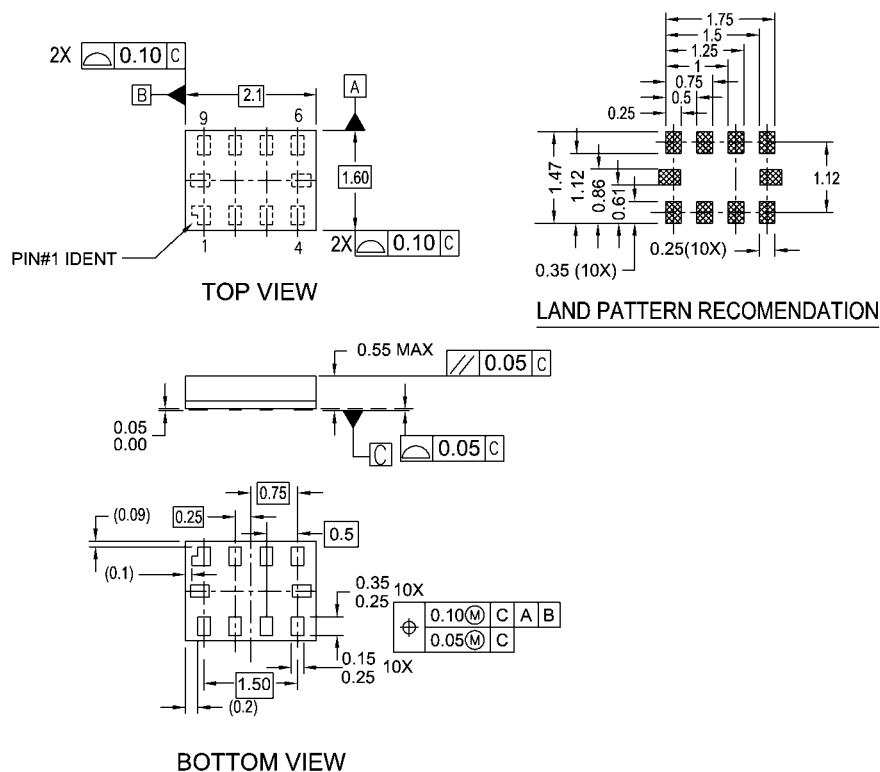
1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00 ± 0.30MM
2. NO INDICATED CORNER RADIUS IS 0.127MM
3. CAMBER NOT TO EXCEED 1MM IN 100MM
4. SMALLEST ALLOWABLE BENDING RADIUS
5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE

REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO255, VARIATION UABD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

MAC010ARevB

10-Lead MicroPak, 1.6 mm x 2.1mm
Package Number MAC010A

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